

Applicant: Stephan Schauz
Application Serial No.: 10/617,925
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Docket No.: 442-191
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IN THE SPECIFICATION:

Please delete the title and insert therefore:

A METHOD FOR THE MANUFACTURE OF AN INJECTION MOLDED CONDUCTOR
CARRYING MEANS

Please replace paragraph [0026] with the following amended paragraph:

[0026] The molding or injection of the second plastic material 15 onto the first supporting substrate 3 is implemented in such a manner that predetermined areas of the first supporting substrate 3 are covered by the second plastic material 15 while other areas remain uncovered and bare. Various different uncovered areas are indicated in figure 3 by reference numeral 6 and 6'. Such areas, which are covered by the molded second plastic material 15, are indicated in figure 2 at 17 as examples.